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**YOSHIMI**(10) **Pub. No.: US 2024/0213858 A1**(43) **Pub. Date: Jun. 27, 2024**(54) **METHOD FOR MANUFACTURING DRIVE  
DEVICE, AND DRIVE DEVICE**(52) **U.S. Cl.**CPC ..... *H02K 11/33* (2016.01); *H02K 5/225*  
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**ABSTRACT**(21) Appl. No.: **18/601,768**(22) Filed: **Mar. 11, 2024****Related U.S. Application Data**(63) Continuation of application No. PCT/JP2022/  
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One end portion of each connector terminal is connected to an end circuit board of an end circuit board assembly. In a first process, a generic circuit board assembly is assembled to a motor frame. In a second process, the end circuit board assembly is assembled to the generic circuit board assembly. In a third process, the other end portion of each connector terminal of the end circuit board assembly is exposed in a mating bore of a corresponding connector, and a connector housing is assembled. The third process is carried out such that a load, which is generated when the other end portion of each connector terminal is exposed in the mating bore of the corresponding connector in the third process, is smaller than a load, which is generated in the first process, and a load, which is generated in the second process.

